

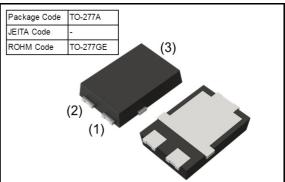
# RBQ5RSM65B

### Schottky Barrier Diode

Data sheet

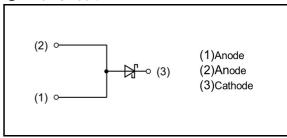
$V_{R}$	65	V
l <sub>o</sub>	5	Α
I <sub>FSM</sub>	100	Α

# Outline



Features
 High reliability
 Power mold type
 Low I<sub>R</sub>

Inner Circuit



ApplicationGeneral rectification

Packaging Specifications

T ackaging opecinications				
Packing	Embossed Tape			
Reel Size(mm)	330			
Taping Width(mm)	12			
Quantity(pcs)	4000			
Taping Code	TL1			
Marking	BQ5RSM65B			

StructureSilicon epitaxial planar

● Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise specified)

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Parameter	Symbol	Conditions	Limits	Unit
Repetitive peak reverse voltage	$V_{RM}$	Duty≦0.5	65	V
Reverse voltage	V <sub>R</sub>	Reverse direct voltage	65	V
Average rectified forward current	lo	60Hz half sin waveform, resistive load, I <sub>0</sub> /2 per diode, T <sub>c</sub> =130°cMax.	5	Α
Peak forward surge current	I <sub>FSM</sub>	60Hz half sin waveform, non-repetitive, per diode, T <sub>a</sub> =25°c	100	Α
Junction temperature <sup>(1)</sup>	Tj	-	150	°C
Storage temperature	T <sub>stg</sub>	-	-55 ~ 150	°C

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill  $dP_d/dT_j < 1/R_{\theta JA}$ .

### Attention

Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction (thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

## ● Electrical Characteristics (T<sub>j</sub>=25°C unless otherwise specified)

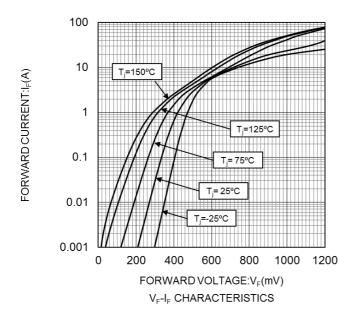
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =5A	-	0.58	0.66	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =65V	-	15	90	μA

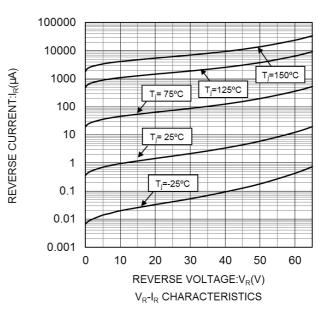
### Thermal Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance (Junction to case) <sup>(1)</sup> (2)	$R_{\theta JC}$	-	-	3.0	°C/W
Thermal Resistance (Junction to ambient) <sup>(1)</sup> (3)		-	-	90	°C/W

注 (1) Value is guaranteed by design.

### Characteristic Curves

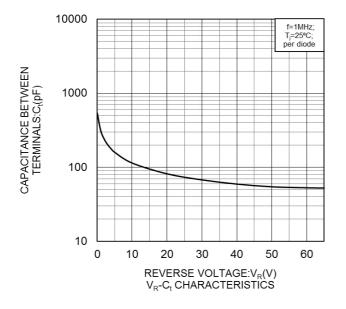


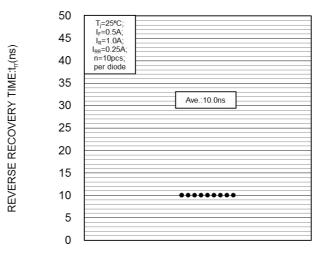


<sup>(2)</sup> Transient dual interface measurement (TDIM) method.

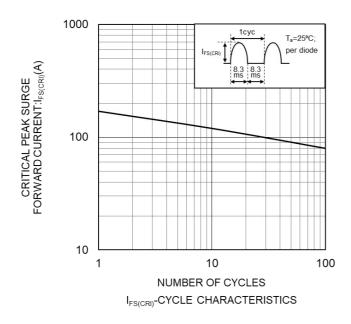
<sup>(3)</sup> Mounted on 50 x 50 x 1.6mm FR4 board, single-sided copper, 35µm thickness, reference footprint.

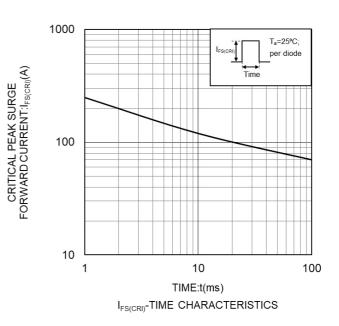
### Characteristic Curves



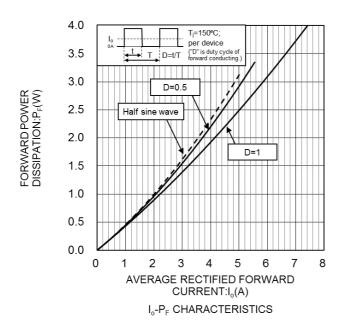


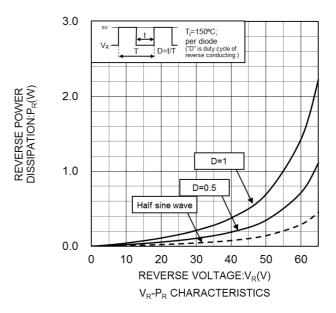
trr DISPERSION MAP

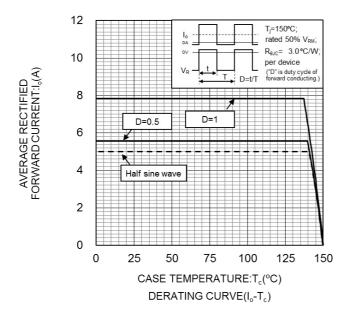




### Characteristic Curves



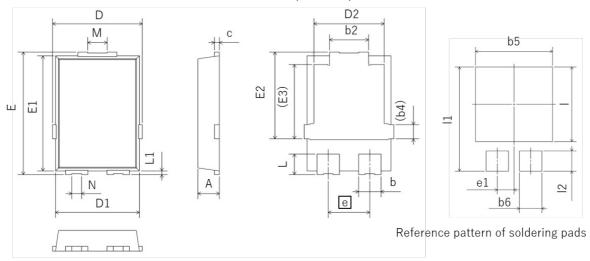




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### Dimensions

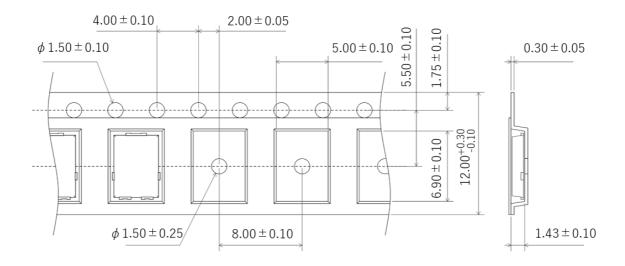
### TO-277A, (TO-277GE)



MIG	DIM Milimeters Max.		Inches		
DIM			Min.	Max.	
Α	1.00	1.20	0.039	0.047	
b	1.05	1.35	0.041	0.053	
b2	1.90	2.20	0.075	0.087	
b4	0.	75	0.0	30	
С	0.15	0.40	0.006	0.016	
D	4.45	4.75	0.175	0.187	
D1	4.25	4.35	0.167	0.171	
D2	3.40	3.70	0.134	0.146	
E	6.35	6.65	0.250	0.262	
E1	6.05	6.15	0.238	0.242	
E2	4.40	4.80	0.173	0.189	
E3	3.94		0.155		
е	2.	2.13		84	
L	0.94	1.24	0.037	0.049	
L1	0.05	0.35	0.002	0.014	
М	0.65	1.15	0.026	0.045	
N	0.25	0.75	0.010	0.030	

DIM	Milimeters	Inches	
ואונט	Тур.	Тур.	
b5	4.80	0.189	
b6	1.40	0.055	
e1	1.04	0.041	
_	4.72	0.186	
11	6.80	0.268	
12	1.27	0.050	

### ● Taping (Unit:mm)



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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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